BC327, BC327-16, BC327-25, BC327-40

Amplifier Transistors PNP Silicon

Features

• Pb–Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CEO}	-45	Vdc
Collector-Base Voltage	V _{CES}	-50	Vdc
Collector – Emitter Voltage	V _{EBO}	-5.0	Vdc
Collector Current – Continuous	۱ _C	-800	mAdc
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above $T_A = 25^{\circ}C$	P _D	625 5.0	mW mW/°C
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above $T_A = 25^{\circ}C$	PD	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

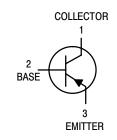
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	R_{\thetaJA}	200	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



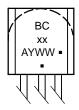
ON Semiconductor®

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MARKING DIAGRAM



BCxx = Device Code A = Assembly Location Y = Year WW = Work Week • = Pb-Free Package ote: Microdot may be in either location

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking, and shipping information in the package dimensions section on page 4 of this data sheet.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BC327, BC327-16, BC327-25, BC327-40

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector – Emitter Breakdown Voltage $(I_{C} = -10 \text{ mA}, I_{B} = 0)$		V _{(BR)CEO}	-45	_	-	Vdc
Collector – Emitter Breakdown Voltage $(I_C = -100 \ \mu A, I_E = 0)$		V _{(BR)CES}	-50	_	_	Vdc
Emitter – Base Breakdown Voltage $(I_E = -10 \ \mu A, I_C = 0)$		V _{(BR)EBO}	-5.0	-	-	Vdc
Collector Cutoff Current ($V_{CB} = -30 \text{ V}, I_E = 0$)		I _{CBO}	_	_	-100	nAdc
Collector Cutoff Current ($V_{CE} = -45 \text{ V}, V_{BE} = 0$)		I _{CES}	_	_	-100	nAdc
Emitter Cutoff Current ($V_{EB} = -4.0 \text{ V}, I_C = 0$)		I _{EBO}	_	-	-100	nAdc
ON CHARACTERISTICS						
DC Current Gain ($I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$) ($I_C = -300 \text{ mA}, V_{CE} = -1.0 \text{ V}$)	BC327 BC327–16 BC327–25 BC327–40	h _{FE}	100 100 160 250 40	- - - -	630 250 400 630 -	-
Base–Emitter On Voltage ($I_C = -300$ mA, $V_{CE} = -1.0$ V)		V _{BE(on)}	_	_	-1.2	Vdc
Collector – Emitter Saturation Voltage $(I_C = -500 \text{ mA}, I_B = -50 \text{ mA})$		V _{CE(sat)}	-	-	-0.7	Vdc
SMALL-SIGNAL CHARACTERISTICS					1	
Output Capacitance $(V_{CB} = -10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz})$		C _{ob}	-	11	_	pF
Current-Gain – Bandwidth Product ($I_C = -10 \text{ mA}, V_{CE} = -5.0 \text{ V}, f = 100 \text{ MHz}$)		f _T	-	260	-	MHz

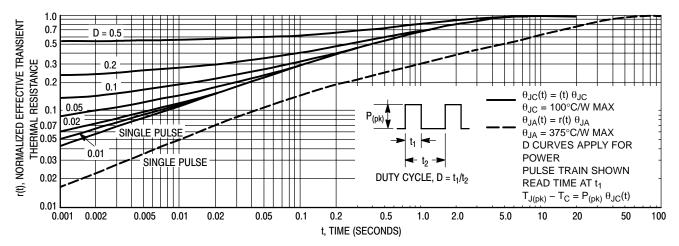


Figure 1. Thermal Response

BC327, BC327-16, BC327-25, BC327-40

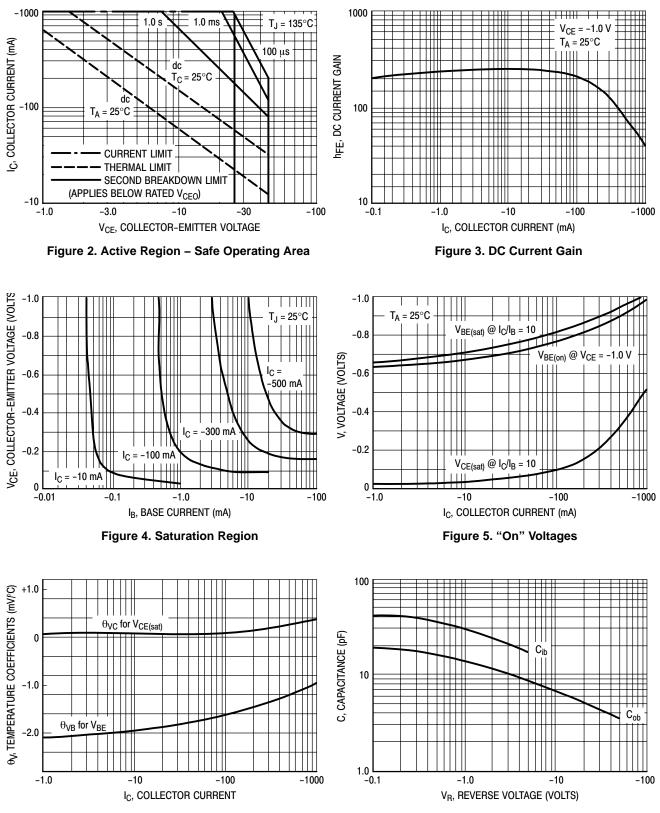




Figure 7. Capacitances

BC327, BC327–16, BC327–25, BC327–40

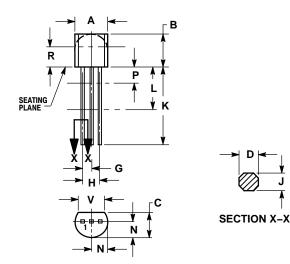
ORDERING INFORMATION

Device Order Number	Specific Device Marking	Package Type	Shipping [†]	
BC327	7	TO-92	5000 Units / Bulk	
BC327G	7	TO-92 (Pb-Free)	5000 Units / Bulk	
BC327RL1	327	TO-92	2000 / Tape & Reel	
BC327RL1G	327	TO-92 (Pb-Free)	2000 / Tape & Reel	
BC327ZL1	327	TO-92	2000 / Tape & Ammo Box	
BC327ZL1G	327	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
BC327-016	327	TO-92	5000 Units / Bulk	
BC327-016G	327	TO-92 (Pb-Free)	5000 Units / Bulk	
BC327-016ZL1	32716	TO-92	2000 / Tape & Ammo Box	
BC327-016ZL1G	32716	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
BC327-25RL1	7–25	TO-92	2000 / Tape & Reel	
BC327-25RL1G	7–25	TO-92 (Pb-Free)	2000 / Tape & Reel	
BC327-25ZL1	32725	TO-92	2000 / Tape & Ammo Box	
BC327-25ZL1G	32725	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
BC327-040	327	TO-92	2000 / Tape & Reel	
BC327-040G	327	TO-92 (Pb-Free)	2000 / Tape & Reel	
BC327-40ZL1	7–40	TO-92	2000 / Tape & Ammo Box	
BC327-40ZL1G	7–40	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

2.

CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 3. LEAD DIMENSION IS UNCONTROLLED IN P AND

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
c	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Η	0.095	0.105	2.42	2.66
ſ	0.015	0.020	0.39	0.50
Κ	0.500		12.70	
L	0.250		6.35	
Ν	0.080	0.105	2.04	2.66
Ρ		0.100		2.54
R	0.115		2.93	
<	0.135		3.43	

STYLE 17:

PIN 1. COLLECTOR BASE 2.

3. EMITTER

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